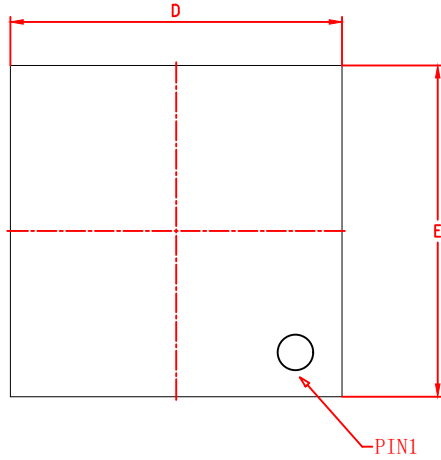


TOP VIEW

正视图



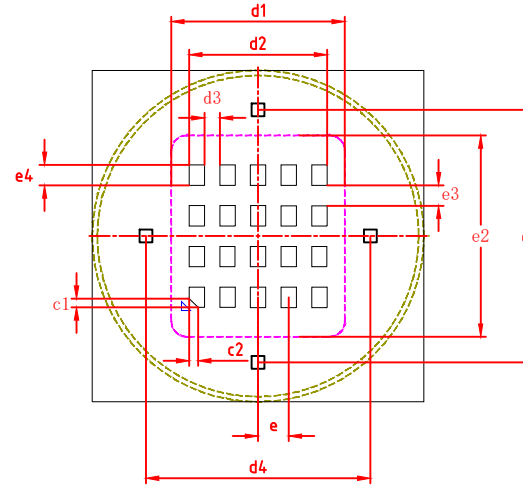
SIDE VIEW

侧视图



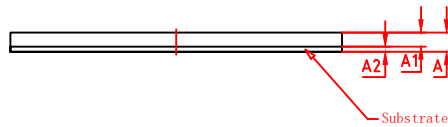
BOTTOM VIEW

背视图




SIDE VIEW

侧视图



机械尺寸/mm

字符 SYMBOL	最小值 MIN	典型值 NOMINAL	最大值 MAX
D	12.900	13.000	13.100
E	12.900	13.000	13.100
A	0.720	0.750	0.780
A1	0.527	0.547	0.567
A2	0.193	0.203	0.213
c1	0.300	0.350	0.400
c2	0.300	0.350	0.400
d1	6.700	6.800	6.900
d2	5.400 BSC		
d3	5.900	0.600	0.610
d4	8.700	8.800	8.900
e	1.200 BSC		
e1	9.800	9.900	10.000
e2	7.800	7.900	8.000
e3	0.790	0.800	0.810
e4	0.790	0.800	0.810

 池州华宇电子科技股份有限公司 CHI ZHOU HI SEMI ELECTRONICS TECHNOLOGY CO.,LTD					制图: Draw	NINGLIN 2024. 5. 21
图号 Drawing NO.	HY-POD-LGA0015				制图核查: Drawing review	
Title 产品外形图	PACKAGE OUTLINE DIMENSIONS LGA24L (13. 0×13. 0×0. 75-P1. 20)				审核: Checker	
幅图 size	页数 page	单位 unit	比例 scale	视图 view	核准: Approved	
A4	1	mm	1:1	